

#### POWER MANAGEMENT Description

The SC2450 can be configured as a dual converter or a bi-phase converter for high current applications. The part is designed for point of use power supplies with 8.5-30V nominal backplane power sources. Multiple supplies can be synchronized together to prevent low frequency harmonics on the backplane. The power dissipation is controlled using a novel low voltage supply technique, allowing high speed and integration, with the high drive currents to ensure low MOSFET switching loss.

The use of high speed switching circuits allows very narrow PWM outputs down to 15:1 voltage ratios. Single pin compensation for each channel simplifies development as well as reducing external pin count.

Capable of driving MOSFETs via external driver transistors for phase currents beyond 20A.

#### Features

- Selectable dual output or bi-phase operation
- Direct drive for N-channel MOSFETs
- Undervoltage lockout
- Synchronization to external clock
- Multi-converter synchronization
- Soft start
- Fast transient response
- Max duty cycle 45%
- Output over voltage protection
- Thermal shutdown
- 28-Pin SO lead free package available. Fully WEEE and RoHS compliant

#### Applications

- Power supplies for advanced telecoms/datacoms
- SO IP, Ethernet and PABX power supplies



Typical Application Circuit



#### Absolute Maximum Ratings

Exceeding the specifications below may result in permanent damage to the device, or device malfunction. Operation outside of the parameters specified in the Electrical Characteristics section is not implied.

Parameter	Symbol	Maximum	Units
Supply Voltage	V <sub>IN</sub>	34	V
Voltage on BST Pins	V <sub>BST</sub>	42	V
Oscillator Frequency (1)		2	MHz
VCC		8	V
Thermal Resistance Junction to Case	$\theta_{JC}$	25	°C/W
Thermal Resistance Junction to Ambient	$\theta_{JA}$	80	°C/W
Operating Temperature Range	T <sub>A</sub>	-40 to +85	°C
Storage Temperature Range	T <sub>STG</sub>	-55 to +150	°C
Lead Temperature (Soldering) 10 seconds	T	300	°C

Note: (1) Maximum frequency and maximum supply voltage could cause excessive power dissipation in the part.

#### **Electrical Characteristics**

Unless specified  $V_{IN}$  = 24V,  $T_A$  = 25°C

Parameter	Conditions	Min	Тур	Мах	Units
Supply Voltage, V <sub>IN</sub>		8.5		30	V
Supply Current	ENABLE = 0		30	40	mA
Under Voltage Lockout			5.8		V
UVLO Hysteresis			400		mV
Voltage Regulator					
Pre Regulator Voltage		6		7	V
Bgout Voltage	C <sub>REF</sub> = 4.7nF	0.99	1	1.01	V
Bgout Impedance			3		KΩ
REGDRV Pin Sink Current	l REGDRV		5		mA
Error Amp					
Input Offset Voltage				15	mV
Input Offset Mismatch				4	mV
Input Impedance		5			KΩ
Linear Transconductance			.002		A/V
Internal Oscillator					
Frequency	R <sub>REF</sub> = 30K		1		MHz
Frequency	R <sub>REF</sub> = 60K		500		kHz
Ramp Valley to Peak	V <sub>IN</sub> = 12V		1.5		V
Ramp Valley to Peak	V <sub>IN</sub> = 24V		3		V

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#### **POWER MANAGEMENT**

## Electrical Characteristics (Cont.) Unless specified $V_{IN} = 24V$ , $T_A = 25 °C$

Parameter	Conditions	Min	Тур	Max	Units	
External Clock						
Detect Time	Rise Time < 50ns			2	μs	
Unlock Time		10		50	μs	
Frequency Range		0.27		1	MHz	
High Side Gate Drive						
Max Duty Cycle			45		%	
Peak Source	C <sub>LOAD</sub> = 10nF		1		А	
Peak Sink	C <sub>LOAD</sub> = 10nF		1		А	
Low Side Gate Drive						
Peak Source	C <sub>LOAD</sub> = 10nF		2		А	
Peak Sink	C <sub>LOAD</sub> = 10nF		2		А	
Sync Drive Timing						
Min Non-overlap	C <sub>LOAD</sub> = 1nF Fet Drive < 1V	20	50		ns	
PWM Match	50% Duty Cycle, F <sub>osc</sub> = 1MHz	-1		1	%	
Logic Input Pins						
Input Bias Current	V <sub>IN</sub> = 0 - 5V	-10		10	μA	
Logic Threshold			0.8		V	
FB2 Disable Threshold			V <sub>cc</sub> - 0.7V		V	
Over Current Protection						
OCP Threshold		103	115	127	mV	
OC+ I/P Bias Current	V <sub>IN</sub> = 24V		700		μA	
OC- I/P Bias Current			50		μA	
Over Voltage Protection						
OVP Threshold			120		%	
Thermal Shutdown			150		°C	

Note:

(1) This device is ESD sensitive. Use of standard ESD handling precautions is required.





#### Pin Configuration

**Block Diagram** 



#### **Ordering Information**

Part Number	PACKAGE <sup>(1)</sup>	T <sub>AMB</sub> (T <sub>A</sub> )		
SC2450ISWTR	00.00	40 · • 05°0		
SC2450ISWTRT <sup>(2)</sup>	50-28	-40 - +85°C		
SC2450EVB	SC2450 Evaluation Board			

#### Notes:

(1) Only available in tape and reel packaging. A reel contains 1000 devices.

(2) Lead free product. This product is fully WEEE and RoHS compliant.

#### BGOUT ENABLE 0C-2 0C-1 0C+ Vcc Vcc ≥²k Ś₂к >NC urren Limit >NC Vçc Ş Vcc 11 50uA Vcc REGDRV . JVLO Bandgap Voltage Feed Forward Vcc Current Limit 4 2.05V Reference VCC w Vcc<sub>o</sub> EXTCLK 0 1-Shot Vçc Vcc Vçc 5 Auto Clock Divide/2 OSC BIAS BSTH1 DRVH1 Vcc AGND Q5 (Q6 7 PHASE1 Vcc q 1-Shot PWM Vcc BSTL1 C1 24pf Vçc Q10 DRVL1 One Vçc CLKOUT Clock Output Shot A–B Switch BSTH2 Vçc Vçc DRVH2 Voltage ()-Feed Forward Bgout ⊶ Q1' Vçc PHASE2 Over-Voltage BSTL2 Thermal DRVL2 013 Shutdow PGND 4 RREF FB1 COMP1 FB2 COMP2

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## Pin Descriptions

Pin	Pin Name	Pin Function
1	FB1	Feedback for channel 1.
2	COMP1	Compensation for channel 1.
3	NC	No connection.
4	BG	1V reference for error amplifiers, 3K source impedance.
5	FB2	Feedback for channel 2.
6	COMP2	Compensation for channel 2.
7	REGDRV	Regulator drive for external pass transistor.
8	ENABLE	Enable threshold is 2.05 V, connect to ground to disable.
9	PHASE2	Phase node input for channel 2.
10	DRVH2	Gate drive for high side channel 2.
11	BSTH2	Bootstrap input for high side channel 2.
12	DRVL2	Gate drive for low side channel 2.
13	BSTL2	Supply for low side channel 2.
14	VCC	Pre-regulated IC power supply.
15	BSTL1	Supply for low side channel 1.
16	DRVL1	Gate drive for low side channel 1.
17	BSTH1	Bootstrap input for high side channel 1.
18	DRVH1	Gate drive for high side channel 1.
19	PHASE1	Phase node input for high side channel 1.
20	PGND	Power ground.
21	OC+	Overcurrent comparator inverting input.
22	OC-2	Overcurrent comparator non-inverting input for channel 2.
23	OC-1	Overcurrent comparator non-inverting input for channel 1.
24	EXTCLK	External clock, converter locks to this input when a valid signal is present.
25	CLKOUT	Clock out, logic level drive to provide synchronizing signal for other converters.
26	NC	No connection.
27	AGND	Analog ground.
28	RREF	External reference resistor for internal oscillator and ramp generator.



#### **Typical Application**

#### **Schematic for Two Channel Operation**



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## POWER MANAGEMENT

#### Typical Application (Cont.)

#### **Bill of Material for Two Channel Operation**

ltem	Qty	Reference	Part Number/Value	Manufacturer
1	8	C1 - C8	0.47µF, 50V, Cer.	Any
2	3	C9,C24,C25	0.33µF, Cer., 1206	Any
3	2	C10,C11	22nF, Cer., 1206	Any
4	1	C12	0.1µF, Cer., 1206	Any
5	2	C13,C14	10nF, Cer., 1206	Any
6	1	C15	47pF, Cer., 1206	Any
7	6	C16,C19,C20,C21,C22,C23	22µF, 35V, Tant.	Any
8	2	C17,C18	680µF, 35V, Alum.	Any
9	2	C26,C27	2.2nF, Cer., 1206	Any
10	3	C28,C29,C50	1.0nF, Cer., 1206	Any
11	1	C30	1.0µF, Cer., 1206	Any
12	11	C31,C32,C33,C36,C37,C40,C41,C42,C43,C44,C45	10µF, Cer., 1206	Any
13	4	C34,C35,C38,C39	1500µF, 6.3V, Alum.	Any
14	4	D1,D2,D5,D6	1A, 40V, Schottky, MELF, 1N5819M	Any
15	2	D3,D4	3A, 40V, Schottky, 30BQ040	Any
16	2	L1,L2	Inductor, 9 turns	Magnetics: Kool Mu P/N: 77206-A7
17	4	M1,M2,M3,M4	N-Channel MOSFET, TO- 263AB	Fairchild P/N: FDB7030BL
18	1	Q1	80V, 1A, NPN, Med. Pwr. SOT-223	BCP56CT
19	2	R1,R3	2.2, 5%, 1206	Any
20	2	R4,R6	4.7, 5%, 1206	Any
21	4	R2,R5,R7,R11	1.0, 5%, 1206	Any
22	1	R8	56k, 5%, 1206	Any
23	2	R9,R10	2.2k, 5%, 1206	Any
24	1	R12	Chip resistor, 0.005, 1W, 1%, 2512	Any



#### Typical Application (Cont.)

#### Bill of Material for Two Channel Operation (Cont.)

ltem	Qty	Reference	Part Number/Value	Manufacturer
25	4	R13,R14,R15,R16	2.2, 1/4W, 5%, 1210	Any
26	1	R17*,R19,R31*	Chip resistor, 0, 1206	Any
27	2	R20,R21	1.00k, 1%, 1206	Any
28	1	R22	2.32k, 1%, 1206	Any
29	1	R23	4.02k, 1%, 1206	Any
30	2	R26,R27	20, 5%, 1206	Any
31	1	R28	10, 5%, 1206	Any
32	1	R29	51, 5%, 1206	Any
33	1	R34	15k, 5%, 1206	Any
34	1	R36	68.1k, 1%, 1206	Any
35	1	R37	10.0k, 1%, 1206	Any
36	0	Roc1*,Roc2*	TBD, 1%, 1206	Any
37	1	SC2450	Bi-Phase/Dual Controller, SO-28W	Semtech Corp. P/N: SC2450ISW 805-498-2111

Notes:

1. \* Indicates optional parts.

2. Some parts are selected due to availability or lead time, and are not optimized.



#### Typical Application (Cont.)

#### Schematic for Bi-Phase Operation





Electrical Characteristic Curves

#### **Two Channel Operation**

#### Efficiency in Two-Channel Application Circuit (5V/12A, 3.3V/18A)



Phase Node Waveform of Two-Channel Application Circuit (Vin = 24V, Load Current = 12A for 5V, Load Current = 18A for 3.3V)





Electrical Characteristic Curves (Cont.)

#### 3.3V Channel Gate Waveform (Vin = 24V, Load Current = 18A)



5.0V Channel Gate Waveform (Vin = 24V, Load Current = 12A)





#### **Bi-Phase Operation (Vout = 3.3V, Max. Load Current = 20A)** Efficiency in Bi-Phase Application Circuit (3.3V/20A)





#### Electrical Characteristic Curves (Cont.)

#### Phase Node Waveform (Vin = 24V, Vout = 3.3V, Load Current = 20A)



Gate Waveform (Vin = 24V, Vout = 3.3V, Load Current = 10A/phase)



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#### POWER MANAGEMENT

Electrical Characteristic Curves (Cont.)

Start-up (Vin = 24V, Vout = 3.3V, Load Current = 5A/phase)



#### Theory of Operation

The SC2450 employs a voltage mode control with feed forward to provide fast output response to load and line transients.

The SC2450 has two outputs, which can be used to generate two separate supply voltages or can be combined in bi-phase operation to generate one single supply voltage. The internal reference is trimmed to 1 V with +/-1% accuracy, and the outputs voltages can be adjusted by two external resistors. In bi-phase operation, the dual switching regulators are operated  $180^{\circ}$  out of phase. Load current sharing between phases is normally required, and this can be achieved by using precise feedback voltage divider resistors (typically 0.1%) to match individual phase output voltage. In addition, small drooping resistors (could be PCB traces) are employed at the output of each phase to enhance phase current balance.

#### **PWM Control**

Changes on the output voltages are fed to the inverting input of the Error Amplifiers, by the FB1 and FB2 pins, and compared with the internal 1 V reference. The compensation to the transconductance amplifier is achieved by connecting a capacitor in series with a resistor from the COMP1 and COMP2 pins to AGND respectively. The error signal from the error amplifier is compared to the saw tooth waveform by the PWM comparator, and matched timing signal is generated to control the upper and lower gate drives of the two phases. A single Ramp signal is used to generate the control signals for both of phases, hence the maximum duty cycle is less than 50%.

#### **Oscillator Frequency Selection**

The sawtooth signal is generated by charging an internal capacitor with a current source. The charge current is set by an external resistor connected from the RREF pin to AGND. The oscillator frequency and the external resistance follow an inversely proportional relationship.

#### **Feed Forward**

The SC2450 incorporates a voltage feed forward scheme to improve line transient immunity when changes of the input voltage occur. As the input voltage changes, the ramp valley to peak voltage of the internal oscillator follows this change instantly. As a result the output voltage will have minimum disturbance due to the input line change.

#### Synchronized Operation

The internal oscillator can be synchronized to an external clock operating in the range of 270 kHz to 1 MHz. The switching frequency of each channel is one half of the oscillator frequency. The oscillator clock is also available externally through the CLKOUT pin and can be used to provide synchronization for other converters.



#### Theory of Operation (Cont.)

#### **Bias Generation**

A 6-7 Volt supply voltage is required to power up the SC2450. This voltage could be provided by an external power supply or derived from VIN through an external pass transistor. REGDRV is the control signal to the base of the pass transistor that will regulate VCC. The voltage at the VCC pin is compared to the internal voltage reference, and the REGDRV pin can sink up to 5 mA current to regulate the voltage at the VCC pin.

#### Enable

If the ENABLE pin is connected to logic high, the SC2450 is enabled, while connecting it to ground will put the device into disabled mode. The ENABLE pin can also be configured as input UVLO through input voltage divider resistors. The controller will be enabled when the ENABLE pin voltage reaches 2.05 V, and will be disabled with 400 mV hysteresis.

#### **Under Voltage Lockout**

Under Voltage lockout (UVLO) circuitry senses VCC through a voltage divider. If this signal falls below 5.8 V, with a typical hysteresis of 400 mV, the BG pin is pulled low by an internal transistor causing the lower MOSFET gate to be on and the upper MOSFET gate off for both phases.

#### **Over Voltage Protection**

The SC2450 provides OVP protection for each output individually. Once the converter output voltage exceeds 120% nominal output voltage, the lower MOSFET gates are latched on and the upper MOSFET gates are latched off. The latch is then reset once the OVP condition is removed.

#### Soft Start

An external capacitor at the BG pin is used to set up the Soft Start duration. The capacitor value, in conjunction with the internal 3K resistor at the BG pin, control the duration to bring up the bandgap to its final level. As the BG capacitor is being charged through the internal resistor, the PWM pulse opens accordingly until the bandgap is charged completely. This controlled start up of the PWM prevents output voltage overshoot, unnecessary component stress, and noise generation during start up.

#### **Over Current Protection**

The SC2450 current limit provides protection during an over current condition. A sense resistor or PCB trace can be used to sense the input supply current.

The over current protection trip point is determined by the voltage drop across the sense resistor. Once this voltage drop exceeds 115 mV, OCP protection circuit will be triggered. Due to component and layout parasitics, filtering might be necessary across the OC+ and OC- pins. It is recommended to use 20 Ohm resistor and 10 nF capacitor for filtering. The OCP accuracy may be affected by non-ideal PCB layout and MOSFET variations. To accommodate these variations, the OCP threshold can be externally adjusted by a voltage divider across the sense resistor to attenuate the voltage drop across the sense resistor, so that increase the OCP threshold accordingly. See application circuits.

Once an over current condition occurs, the lower MOSFET gates are latched on and the upper MOSFET gates are latched off. The latch is then reset at the beginning of the next clock cycle. The cycle is repeated indefinitely until the over current condition removed.

#### **Thermal Shutdown**

In addition to current limit, the SC2450 monitors over temperature condition. The over temperature detection will shut down the part if the SC2450 die temperature exceeds 150°C, and will auto reset once the die temperature is dropped down.

#### **Gate Drive**

The SC2450 integrates high current gate drivers for fast switching of large MOSFETs. The high-side gates can be switched with peak currents of 1 Amp, while the larger low-side gates can be switched with peak currents of 2 Amps. A cross conduction prevention circuitry ensures a non-overlapping operation between the Upper and Lower MOSFETs. This prevents false current limit tripping and provides high efficiency.





Fig. 1. SC2450 control model.

The control model of SC2450 can be depicted in Fig. 1. This model can also be used in Spice kind of simulator to generate loop gain Bode plots. The bandgap reference is 1 V and trimmed to +/-1% accuracy. The desired output voltage can be achieved by setting the resistive divider network, R1 and R2.

The error amplifier is transconductance type with fixed gain of:

$$G_{ERROR} := 0.002 \frac{A}{V}$$

The compensation network includes a resistor and a capacitor in series, which terminates from the output of the error amplifier to the ground.

This device uses voltage mode control with input voltage feed forward. The peak-to-peak ramp voltage is proportional to the input voltage, which results in an excellent performance to reject input voltage variation. The PWM gain is inversion of the ramp amplitude, and this gain is given by:

$$G_{PWM} := \frac{1}{V_{RAMP}}$$

where the ramp amplitude (peak-to-peak) is 3 volts when input voltage is 24 volts.

The total control loop-gain can then be derived as follows:

$$T(s) = T_{o} \cdot \left(\frac{1 + s \cdot R \cdot C}{s \cdot R \cdot C}\right) \cdot \frac{1 + s \cdot R_{o} \cdot C_{o}}{1 + s \cdot \left(R_{o} \cdot C_{o} + \frac{L}{R_{o}}\right) + s^{2} \cdot L \cdot C_{o} \cdot \left(1 + \frac{R_{c}}{R_{o}}\right)}$$

where

$$T_{o} = G_{error} V_{in} G_{pwm} R \left( \frac{R_{2}}{R_{1} + R_{2}} \right)$$

The task here is to properly choose the compensation network for a nicely shaped loop-gain Bode plot. The following design procedures are recommended to accomplish the goal:

(1) Calculate the corner frequency of the output filter:

$$\mathsf{F}_{\mathsf{O}} \coloneqq \frac{1}{2 \bullet \pi \bullet \sqrt{\mathsf{L} \bullet \mathsf{C}_{\mathsf{O}}}}$$

(2) Calculate the ESR zero frequency of the output filter capacitor:

$$\mathsf{F}_{\mathsf{esr}} \coloneqq \frac{1}{2 \bullet \pi \bullet \mathsf{R}_{\mathsf{C}} \bullet \mathsf{C}_{\mathsf{O}}}$$

(3) Check that the ESR zero frequency is not too high.

$$F_{ers} < \frac{F_{SW}}{5}$$

If this condition is not met, the compensation structure may not provide loop stability. The solution is to add some electrolytic capacitors to the output capacitor bank to correct the output filter corner frequency and the ESR zero frequency. In some cases, the filter inductance may also need to be adjusted to shift the filter corner frequency. It is not recommended to use only high frequency multi-layer ceramic capacitors for output filter.

(4) Choose the loop gain cross over frequency (0 dB frequency). It is recommended that the crossover frequency is always less than one fifth of the switching frequency or the output ripple frequency in bi-phase mode operation:

$$\mathsf{F}_{X\_OVER} \leq \frac{\mathsf{F}_{SW}}{5}$$

If the transient specification is not stringent, it is better to choose a crossover frequency that is less than one tenth of the switching frequency for good noise immunity. The resistor in the compensation network can then be calculated as:

$$\mathbf{R} \coloneqq \frac{1}{\mathbf{G}_{pwm} \cdot \mathbf{V}_{in} \cdot \mathbf{G}_{error}} \cdot \left(\frac{\mathbf{F}_{esr}}{\mathbf{F}_{o}}\right)^{2} \cdot \left(\frac{\mathbf{F}_{x_over}}{\mathbf{F}_{esr}}\right) \cdot \left(\frac{\mathbf{V}_{o}}{\mathbf{V}_{bg}}\right)$$

when:

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#### **POWER MANAGEMENT** Control Loop Design (Cont.)

or

$$\mathbf{R} \coloneqq \frac{1}{\mathbf{G}_{pwm} \cdot \mathbf{V}_{in} \cdot \mathbf{G}_{error}} \cdot \left(\frac{\mathbf{F}_{o}}{\mathbf{F}_{esr}}\right)^{2} \cdot \left(\frac{\mathbf{F}_{x}_{over}}{\mathbf{F}_{o}}\right) \cdot \left(\frac{\mathbf{V}_{o}}{\mathbf{V}_{bg}}\right)$$

when

$$F_{esr} < F_o < F_{x_over}$$

(5) The compensation capacitor is determined by choosing the compensator zero to be about one fifth of the output filter corner frequency:

$$F_{zero} := \frac{F_{o}}{5}$$
$$C := \frac{1}{2 \cdot \pi \cdot R \cdot F_{zero}}$$

(6) The final step is to generate the Bode plot, either by using the simulation model in Fig. 1 or using the equations provided here with Mathcad. The phase margin can then be checked using the Bode plot. Usually, this design procedure ensures a healthy phase margin.

An example is given below to demonstrate the procedure introduced above. The parameters of the power supply are given as:

Step 1. Output filter corner frequency

F<sub>0</sub> = 1.453 KHz

SC2450

Step 2. ESR zero frequency:

$$F_{esr} = 2.653 \text{ KHz}$$

Step 3. Check the following condition:

$$F_{ers} < \frac{F_{sw}}{5}$$

Which is satisfied in this case.

Step 4. Choose crossover frequency and calculate compensator R:

$$F_{x_{over}} = 30 \text{ KHz}$$
  
R = 5.89 K $\Omega$ 

Step 5. Calculate the compensator C:

Step 6. Generate Bode plot and check the phase margin. In this case, the phase margin is about 85°C that ensures the loop stability. Fig. 2 shows the Bode plot of the loop.





#### Control Loop Design (Cont.)



Fig. 2. Bode plot of the loop

#### Layout Guidelines

Good layout is necessary for successful implementation of the SC2450 bi-phase/dual controller. Important layout guidelines are listed below.

1). The high power parts should be laid out first. The parasitic inductance of the pulsating power current loop (start from positive end of the input capacitor, to top MOSFET, then to bottom MOSFET back to power ground) must be minimized. The high frequency input capacitors and top MOSFETs should be close to each other. The freewheeling Schottky diode, the bottom MOSFET snubber, and the bottom MOSFET should be placed close to each other. The MOSFET gate drive and current sense loop areas should be minimized. The gate drive trace should be short and wide.

2). The layout of the two phases should be made as symmetrical as possible. The SC2450 controller should be placed in the center of the two phases. Please see evaluation board layout as an example.

3). Separate ground planes for analog and power should

be provided. Power current should avoid running over the analog ground plane. The AGND is star connected to the PGND at the converter output to provide best possible ground sense. Refer to the application schematics, certain components should be connected directly to the AGND.

4). If a multi-layer PCB is used, power layer and ground layer are recommended to be adjacent to each other. Typically the power layer is on the top, followed by the ground layer. This results in the least parasitic inductance in the MOSFET-capacitor power loop, and reduces the ringing on the phase node. The rest of the layers could be used to run DC supply traces and signal traces.

An example of a two-layer PCB layout is given below to illustrate these layout principles.



### Layout Guidelines (Cont.)



![](_page_18_Picture_4.jpeg)

![](_page_19_Picture_0.jpeg)

![](_page_19_Picture_1.jpeg)

## Layout Guidelines (Cont.)

![](_page_19_Picture_4.jpeg)

![](_page_20_Picture_0.jpeg)

![](_page_20_Figure_3.jpeg)

![](_page_20_Figure_4.jpeg)

## Land Pattern - SO-28

![](_page_20_Figure_6.jpeg)

#### **Contact Information**

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